Switching Transistor

PNP Silicon

Features

- Moisture Sensitivity Level: 1
- ESD Rating: Human Body Model; 4 kV, Machine Model; 400 V
- Pb-Free Package is Available

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V _{CEO}	-40	Vdc
Collector-Base Voltage	V _{CBO}	-40	Vdc
Emitter-Base Voltage	V _{EBO}	-5.0	Vdc
Collector Current – Continuous	Ι _C	-600	mAdc

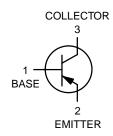
THERMAL CHARACTERISTICS

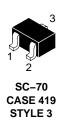
Characteristic	Symbol	Max	Unit
Total Device Dissipation FR–5 Board $T_A = 25^{\circ}C$	P _D	150	mW
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	833	°C/W
Junction and Storage Temperature	T _J , T _{stg}	-55 to +150	°C



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MARKING DIAGRAM



2X = Specific Device Code D = Date Code

ORDERING INFORMATION

Device	Package	Shipping [†]
MMBT4403WT1	SC-70	3000/Tape & Reel
MMBT4403WT1G	SC-70 (Pb-Free)	3000/Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications

Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic		Min	Max	Unit
OFF CHARACTERISTICS				
Collector-Emitter Breakdown Voltage (Note 1) ($I_C = -1.0 \text{ mAdc}, I_B = 0$)	V _{(BR)CEO}	-40	-	Vdc
Collector-Base Breakdown Voltage ($I_C = -0.1 \text{ mAdc}, I_E = 0$)	V _{(BR)CBO}	-40	-	Vdc
Emitter-Base Breakdown Voltage ($I_E = -0.1 \text{ mAdc}$, $I_C = 0$)	V _{(BR)EBO}	-5.0	-	Vdc
Base Cutoff Current (V _{CE} = -35 Vdc, V _{EB} = -0.4 Vdc)	I _{BEV}	-	-0.1	μAdc
Collector Cutoff Current (V _{CE} = -35 Vdc, V _{EB} = -0.4 Vdc)	ICEX	-	-0.1	μAdc

ON CHARACTERISTICS

DC Current Gain	h _{FE}			-
$(I_{C} = -0.1 \text{ mAdc}, V_{CE} = -1.0 \text{ Vdc})$		30	-	
$(I_{C} = -1.0 \text{ mAdc}, V_{CE} = -1.0 \text{ Vdc})$		60	-	
$(I_{C} = -10 \text{ mAdc}, V_{CE} = -1.0 \text{ Vdc})$		100	-	
(I _C = -150 mAdc, V _{CE} = -2.0 Vdc) (Note 1)		100	300	
$(I_{C} = -500 \text{ mAdc}, V_{CE} = -2.0 \text{ Vdc})$ (Note 1)		20	-	
Collector-Emitter Saturation Voltage (Note 1)	V _{CE(sat)}			Vdc
$(I_{C} = -150 \text{ mAdc}, I_{B} = -15 \text{ mAdc})$	- ()	_	-0.4	
$(I_{C} = -500 \text{ mAdc}, I_{B} = -50 \text{ mAdc})$		-	-0.75	
Base-Emitter Saturation Voltage (Note 1)	V _{BE(sat)}			Vdc
(I _C = –150 mAdc, I _B = –15 mAdc)	()	-0.75	-0.95	
$(I_{C} = -500 \text{ mAdc}, I_{B} = -50 \text{ mAdc})$		-	-1.3	

SMALL-SIGNAL CHARACTERISTICS

Current–Gain – Bandwidth Product ($I_C = -20$ mAdc, $V_{CE} = -10$ Vdc, f = 100 MHz)	f _T	200	-	MHz
Collector–Base Capacitance ($V_{CB} = -10 \text{ Vdc}$, $I_E = 0$, f = 1.0 MHz)	C _{cb}	-	8.5	pF
Emitter–Base Capacitance ($V_{BE} = -0.5 \text{ Vdc}$, $I_C = 0$, f = 1.0 MHz)	C _{eb}	-	30	pF
Input Impedance (I _C = -1.0 mAdc, V _{CE} = -10 Vdc, f = 1.0 kHz)	h _{ie}	1.5	15	kΩ
Voltage Feedback Ratio ($I_C = -1.0$ mAdc, $V_{CE} = -10$ Vdc, f = 1.0 kHz)	h _{re}	0.1	8.0	X 10 ⁻⁴
Small-Signal Current Gain (I _C = -1.0 mAdc, V _{CE} = -10 Vdc, f = 1.0 kHz)	h _{fe}	60	500	-
Output Admittance ($I_C = -1.0 \text{ mAdc}$, $V_{CE} = -10 \text{ Vdc}$, $f = 1.0 \text{ kHz}$)	h _{oe}	1.0	100	μmhos

SWITCHING CHARACTERISTICS

Delay Time	$(V_{CC} = -30 \text{ Vdc}, V_{EB} = -2.0 \text{ Vdc},$	t _d	-	15	
Rise Time	$I_{C} = -150 \text{ mAdc}, I_{B1} = -15 \text{ mAdc})$	tr	-	20	ns
Storage Time	$(V_{CC} = -30 \text{ Vdc}, I_C = -150 \text{ mAdc},$	t _s	-	225	
Fall Time	$I_{B1} = I_{B2} = -15 \text{ mAdc}$	t _f	-	30	ns

1. Pulse Test: Pulse Width \leq 300 µs, Duty Cycle \leq 2.0%.

SWITCHING TIME EQUIVALENT TEST CIRCUIT

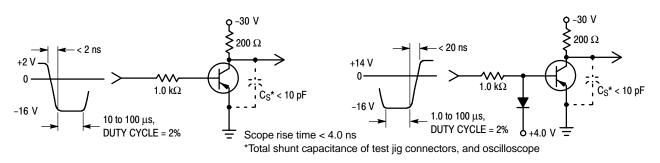
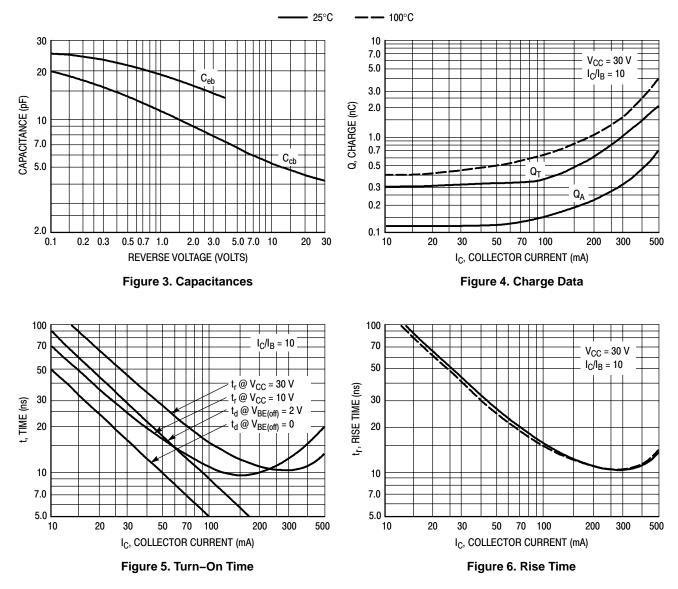


Figure 1. Turn–On Time

Figure 2. Turn-Off Time

TRANSIENT CHARACTERISTICS



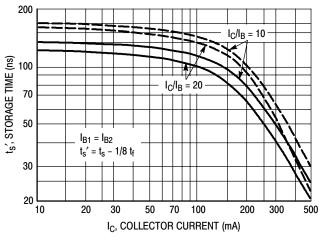
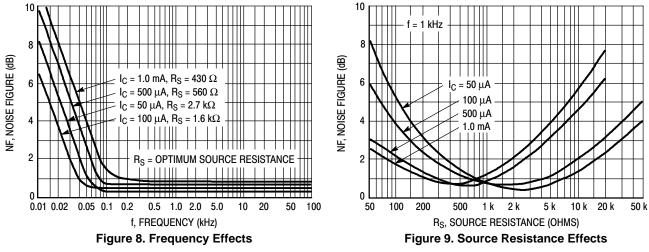


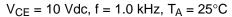
Figure 7. Storage Time

SMALL-SIGNAL CHARACTERISTICS NOISE FIGURE

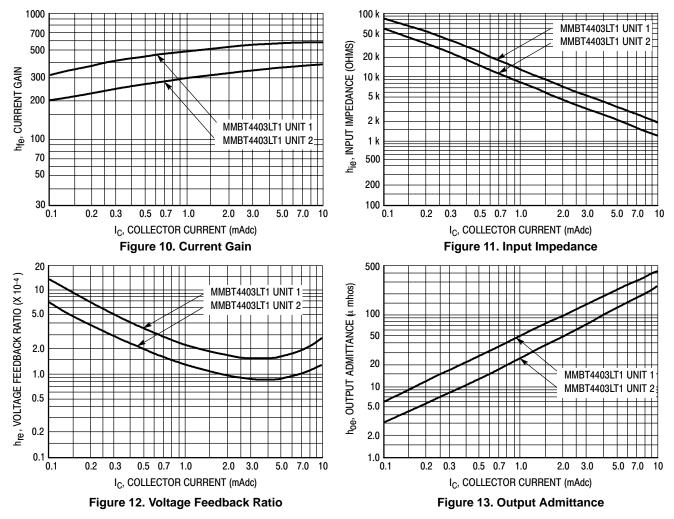
 $V_{CE} = -10$ Vdc, $T_A = 25^{\circ}C$; Bandwidth = 1.0 Hz



h PARAMETERS



This group of graphs illustrates the relationship between h_{fe} and other "h" parameters for this series of transistors. To obtain these curves, a high–gain and a low–gain unit were selected from the MMBT4403LT1 lines, and the same units were used to develop the correspondingly numbered curves on each graph.





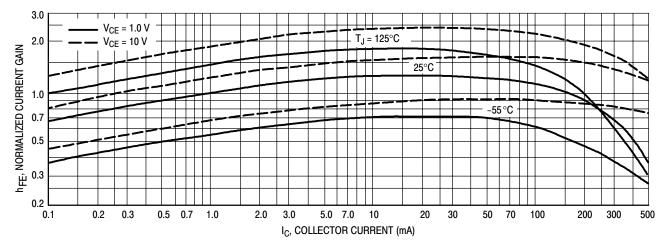
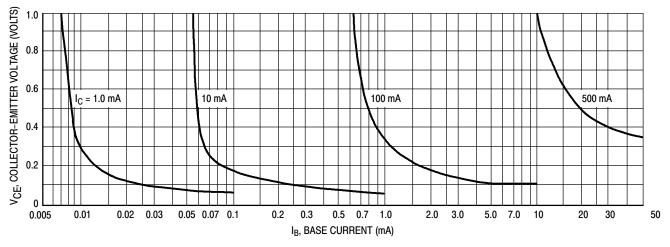
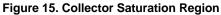


Figure 14. DC Current Gain





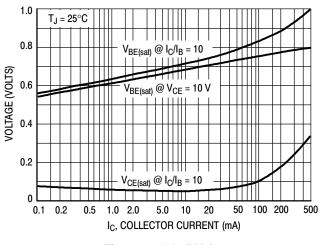
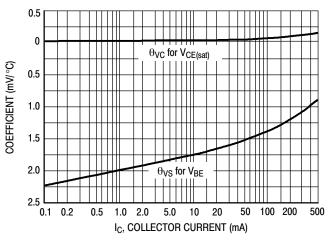


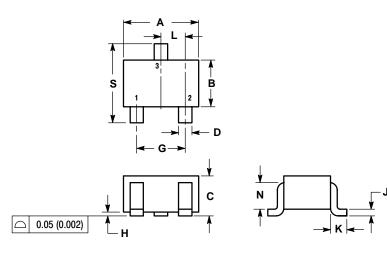
Figure 16. "On" Voltages





PACKAGE DIMENSIONS

SC-70/SOT-323 CASE 419-04 ISSUE L



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI

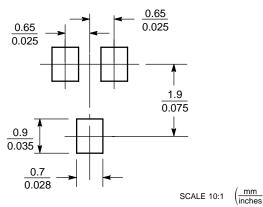
Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.071	0.087	1.80	2.20
В	0.045	0.053	1.15	1.35
c	0.032	0.040	0.80	1.00
D	0.012	0.016	0.30	0.40
G	0.047	0.055	1.20	1.40
Н	0.000	0.004	0.00	0.10
L	0.004	0.010	0.10	0.25
Κ	0.017	' REF	0.425 REF	
Г	0.026 BSC		0.650 BSC	
Ν	0.028	REF	0.700	REF
S	0.079	0.095	2.00	2.40



3. COLLECTOR

SOLDERING FOOTPRINT*



SC-70/SOT-323

*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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